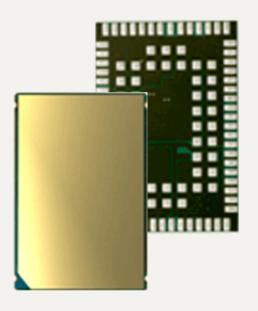


Cinterion® EMS31-V

Hardware Interface Overview

Version: 00.002

Docld: EMS31_V_HIO_v00.002



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1 Introduction

This document¹ describes the hardware of the Cinterion[®] EMS31-V module for Verizon Network. It helps you quickly retrieve interface specifications, electrical and mechanical details and information on the requirements to be considered for integrating further components.

The EMS31-V module includes a baseband, a complete dual band RF front-end, memory and required circuitry to meet the 3GPP E-UTRA Long Term Evolution - LTE, Release 13 CAT M1 set of specifications.

1.1 Key Features at a Glance

Feature	Implementation	
General		
Frequency bands	Band 13, 700 MHz (LTE HD-FDD)	
Output power	Class 3 (+23dBm +-2dB) for LTE 700, LTE FDD B13	
Power supply	3.2V to 5.5V	
Operating temperature (board temperature)	Normal operation: -30°C to +85°C Extended operation: -40°C to +95°C	
Physical	Dimensions: 27.60mm x 18.80mm x 2.05mm Weight: approx. 2.2g	
RoHS	All hardware components fully compliant with EU RoHS Directive	
LTE features		
3GPP Release 13	DL 300 kbps, UL 375 kbps LTE Cat. M1 data rates	
SMS	Point-to-point MT and MO Text mode	
	Storage in mobile equipment	
Software		
AT commands	Hayes, 3GPP TS 27.007, TS 27.005, product specific	
SIM Application Toolkit	SAT Release 99	
Firmware update	Generic update from host application over ASC0 OTA over ASC0	

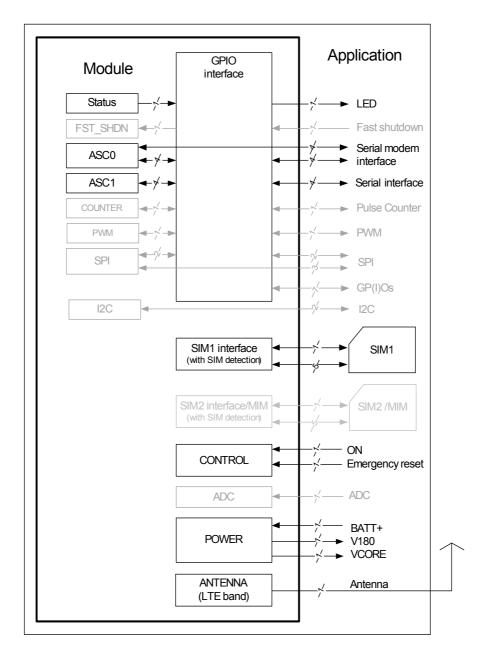
^{1.} The document is effective only if listed in the appropriate Release Notes as part of the technical documentation delivered with your Gemalto M2M product.

Feature	Implementation
Interfaces	
Module interface	Surface mount device with solderable connection pads (SMT application interface). Land grid array (LGA) technology ensures high solder joint reliability and allows the use of an optional module mounting socket.
	For more information on how to integrate SMT modules see also [3]. This application note comprises chapters on module mounting and application layout issues as well as on SMT application development equipment.
2 serial interfaces	 ASC0: 8-wire modem interface with status and control lines, unbalanced, asynchronous Default baud rate: 115,200 baud Adjustable baud rates: 1,200 to 3,686,400 Supports RTS0/CTS0 hardware flow control. Indication of incoming data/SMS on RING0 (can be used to wake up host from power down modes) ASC1 (shared with GPIO lines): 4-wire, unbalanced asynchronous interface Default baud rate: 115,200 baud Adjustable baud rates: 1,200 to 3,686,400bps Supports RTS1/CTS1 hardware flow control
UICC interface	Supported SIM/USIM cards: 3V, 1.8V
Embedded UICC	Module is hardware prepared for an embedded UICC (MIM)
GPIO interface	20 pads of the application interface programmable as GPIO pads (17) or GPO pads (3): GP(I)Os can be configured as ASC0 and ASC1 Programming is done via AT commands
SDIO	EMS51 only: 4 wire interface.
HSIC	EMS51 only: High Speed Interchip Communication interface.
Digitial audio interface	Hardware prepared for future use.
Antenna interface pad	50Ω LTE antenna
Power on/off, Reset	
Power on/off	Switch-on by hardware signal ON Switch-off by AT command Automatic switch-off in case of critical temperature and voltage conditions
Reset	Orderly shutdown and reset by AT command
Evaluation kit	
Evaluation module	EMS31-V module soldered onto a dedicated PCB that can be connected to an adapter in order to be mounted onto the DSB75.

1.1 Key Features at a Glance

Feature	Implementation
DSB75	DSB75 Development Support Board designed to test and type approve Gemalto M2M modules and provide a sample configuration for application engineering. A special adapter is required to connect the EMS31-V evaluation module to the DSB75.

1.2 EMS31-V System Overview



Note: The following features are not yet available with the current product release: GPIO, I²C, Pulse Counter, PWM, FST_SHDN, SPI, ADC and 2nd SIM/MIM. Second SIM/MIM interface is hardware prepared only.

Figure 1: EMS31-V system overview

2 Interface Characteristics

EMS31-V is equipped with an SMT application interface that connects to the external application. The SMT application interface incorporates the various application interfaces as well as the RF antenna interfaces.

2.1 Application Interface

2.1.1 Serial Interface ASC0

EMS31-V offers an 8-wire unbalanced, asynchronous modem interface ASC0 conforming to ITU-T V.28 protocol DCE signaling. The electrical characteristics do not comply with ITU-T V.28. The significant levels are 0V (for low data bit or active state) and 1.8V (for high data bit or inactive state).

EMS31-V is designed for use as a DCE. Based on the conventions for DCE-DTE connections it communicates with the customer application (DTE) using the following signals:

- Port TXD @ application sends data to the module's TXD0 signal line
- · Port RXD @ application receives data from the module's RXD0 signal line

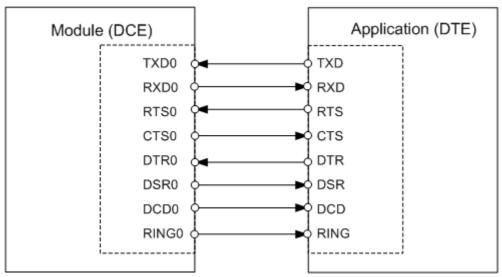


Figure 2: Serial interface ASC0

Features:

- Includes the data lines TXD0 and RXD0, the status lines RTS0 and CTS0 and, in addition, the modem control lines DTR0, DSR0, DCD0 and RING0.
- Configured for 8 data bits, no parity and 1 stop bit.
- ASC0 can be operated at fixed bit rates from 1,200bps up to 3,686,400bps.
- Autobauding (supported by future firmware version)
- Supports RTS0/CTS0 hardware flow control. Communication is possible by using only RXD and TXD lines, if RTS0 is pulled low.

2.1.2 Serial Interface ASC1

EMS31-V provides a 4-wire unbalanced, asynchronous modem interface ASC1 conforming to ITU-T V.24 protocol DCE signaling. The electrical characteristics do not comply with ITU-T V.28. The significant levels are 0V (for low data bit or active state) and 1.8V (for high data bit or inactive state).

EMS31-V is designed for use as a DCE. Based on the conventions for DCE-DTE connections it communicates with the customer application (DTE) using the following signals:

- Port TXD @ application sends data to module's TXD1 signal line
- Port RXD @ application receives data from the module's RXD1 signal line

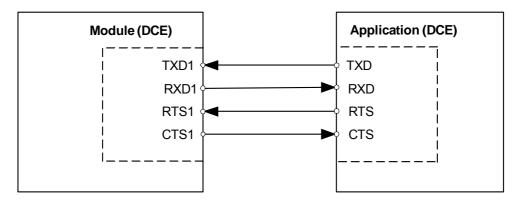


Figure 3: Serial interface ASC1

Features

- Includes only the data lines TXD1 and RXD1 plus RTS1 and CTS1 for hardware handshake.
- On ASC1 no RING line is available.
- Configured for 8 data bits, no parity and 1 or 2 stop bits.
- ASC1 can be operated at fixed bit rates from 1,200 bps to 3,686,400bps.
- Supports RTS1/CTS1 hardware flow control. Communication is possible by using only RXD and TXD lines, if RTS1 is pulled low.

2.1.3 UICC/SIM/USIM Interface

EMS31-V has two identical integrated UICC/SIM/USIM interfaces compatible with the 3GPP 31.102 and ETSI 102 221. These two interfaces are mutually exclusive, meaning that only one UICC/SIM/USIM interface can be used at a time. This interface is wired to the host interface in order to be connected to an external SIM card holder. Five pads on the SMT application interface are reserved for each SIM interface.

The UICC/SIM/USIM interface supports 3V and 1.8V SIM cards.

The CCINx signal serves to detect whether a tray (with SIM card) is present in the card holder. The CCINx signal must be connected to V180 for the detection to work on the module. Otherwise the SIM card can never be detected by the module.

Using the CCINx signal is mandatory for compliance with the GSM 11.11 recommendation if the mechanical design of the host application allows the user to remove the SIM card during operation. To take advantage of this feature, an appropriate SIM card detect switch is required on the card holder. For example, this is true for the model supplied by Molex, which has been tested to operate with EMS31-V and is part of the Gemalto M2M reference equipment submitted for type approval. See Section 7.1 for Molex ordering numbers.

 Table 1: Signals of the SIM interface (SMT application interface)

Signal	Description
GND	Separate ground connection for SIM card to improve EMC.
CCCLKx	Chipcard clock
CCVCCx	SIM supply voltage.
CCIOx	Serial data line, input and output.
CCRSTx	Chipcard reset
CCINx	Input on the baseband processor for detecting a SIM card tray in the holder. If the SIM is removed during operation the SIM interface is shut down immediately to prevent destruction of the SIM. The CCINx signal is by default low and will change to high level if a SIM card is inserted. The CCINx signal is mandatory for applications that allow the user to remove the SIM card during operation. The CCINx signal is solely intended for use with a SIM card. It must not be used for any other purposes. Failure to comply with this requirement may invalidate the type approval of EMS31-V. Pull-down 220k resistor is mandatory.

Note: No guarantee can be given, nor any liability accepted, if loss of data is encountered after removing the SIM card during operation. Also, no guarantee can be given for properly initializing any SIM card that the user inserts after having removed the SIM card during operation. In this case, the application must restart EMS31-V.

The figure below shows a circuit to connect an external SIM card holder.

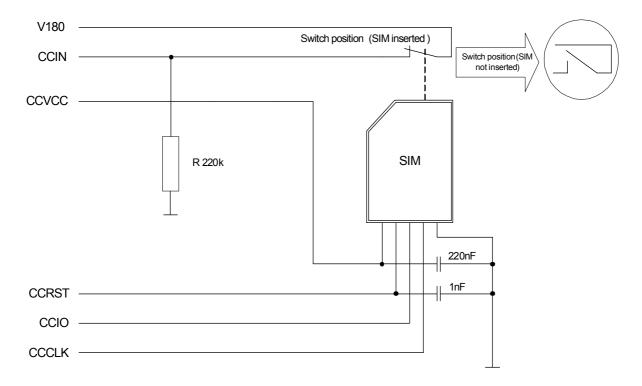


Figure 4: External UICC/SIM/USIM card holder circuit

The total cable length between the SMT application interface pads on EMS31-V and the pads of the external SIM card holder must not exceed 100mm in order to meet the specifications of 3GPP TS 51.010-1 and to satisfy the requirements of EMC compliance.

To avoid possible cross-talk from the CCCLKx signal to the CCIOx signal be careful that both lines are not placed closely next to each other. A useful approach is using a GND line to shield the CCIOx line from the CCCLKx line.

2.1.4 GPIO Interface

EMS31-V offers a GPIO interface with 20 GPIO lines. The lines are shared with other interfaces or functions: ASC0 (see Section 2.1.1), ASC1 (see Section 2.1.2),

The following table shows the configuration variants for the GPIO pads. All variants are mutually exclusive, i.e. a pad configured for instance as ASC0 is locked for alternative usage.

Table 2: GPIO lines and possible alternative assignment

GPIO*	Fast Shut- down*	Status LED	Pulse Counter*	ASC0	ASC1	SPI*	PWM*	WAKE capability
GPIO1				DTR0				Available
GPIO2				DCD0				
GPIO3				DSR0				
GPIO4	FST_SHD N							
GPO5		LED						
GPIO6							PWM2	
GPIO7							PWM1	
GPIO8			COUNTER					Available
GPIO16					RXD1			
GPIO17					TXD1			
GPIO18					RTS1			Available
GPIO19					CTS1			
GPIO20								
GPIO21								
GPIO22								
GPO23								
GPIO24				RING0				
GPIO25								Available
GPO26						SPI_CS 1		
GPIO27						SPI_CS 2		
n/a				RST0				Available

^{*)} Note: The following features are not yet available with the current product release: GPIO, I²C, Pulse Counter, PWM, FST_SHDN and SPI.

After startup, the above mentioned alternative GPIO line assignments can be configured using AT commands (see [1]). The configuration is non-volatile and available after module restart.

2.1.5 Control Signals

2.1.5.1 Status LED

Note that this feature is not available with release 1.

The LED line can also be configured as GPO5 line, and can be used to drive a status LED that indicates different operating modes of the module (for GPOs see Section 2.1.4). LED and GPIO5 functionality are mutually exclusive.

2.2 RF Antenna Interface

The RF interface has an impedance of 50Ω . EMS31-V is capable of sustaining a 10:1 voltage standing wave ratio (VSWR) mismatch at the antenna line without any damage, even when transmitting at maximum RF power.

The external antenna must be matched properly to achieve best performance regarding radiated power, modulation accuracy and harmonic suppression. Antenna matching networks are not included on the EMS31-V module and should be placed in the host application if the antenna does not have an impedance of 50Ω .

Regarding the return loss EMS31-V provides the following values in the active band:

Table 3: Return loss in the active band

State of module	Return loss of module	Recommended return loss of application
Receive	≥ 8dB	≥ 12dB
Transmit	not applicable	≥ 12dB

2.2.1 Antenna Installation

The antenna is connected by soldering the antenna pad (RF_OUT, pad #59) its neighboring ground pads (GND, i.e., pads #58 and #60) directly to the application's PCB. The antenna pad is the antenna reference point (ARP) for EMS31-V. All RF data specified throughout this document is related to the ARP.

The distance between the antenna RF pads and its neighboring GND pads has been optimized for best possible impedance. On the application PCB, special attention should be paid to these 3 pads, in order to prevent mismatch.

The wiring of the antenna connection line, starting from the antenna pad to the application antenna should result in a 50Ω line impedance. Line width and distance to the GND plane needs to be optimized with regard to the PCB's layer stack.

To prevent receiver desensitization due to interferences generated by fast transients like high speed clocks on the application PCB, it is recommended to realize the antenna connection line using embedded Stripline rather than Microstrip line technology.

For type approval purposes an external application must connect the RF signal in one of the following ways:

- Via 50Ω coaxial antenna connector (common connectors are U-FL or SMA) placed as close as possible to the module's antenna pad.
- By soldering the antenna to the antenna connection line on the application's PCB (without the use of any connector) as close as possible to the module's antenna pad.
- By routing the application PCB's antenna to the module's antenna pad in the shortest way.

In case FCC certification of application using EMS31-V is required, the implementation of the connection between module's antenna pad and antenna has to be designed similar to the implementation of this connection on evaluation board and according to KDB 996369 related to modular approval requirements.

2.3 Sample Application

Figure 5 shows a typical example of how to integrate an EMS31-V module with an application. Usage of the various host interfaces depends on the desired features of the application.

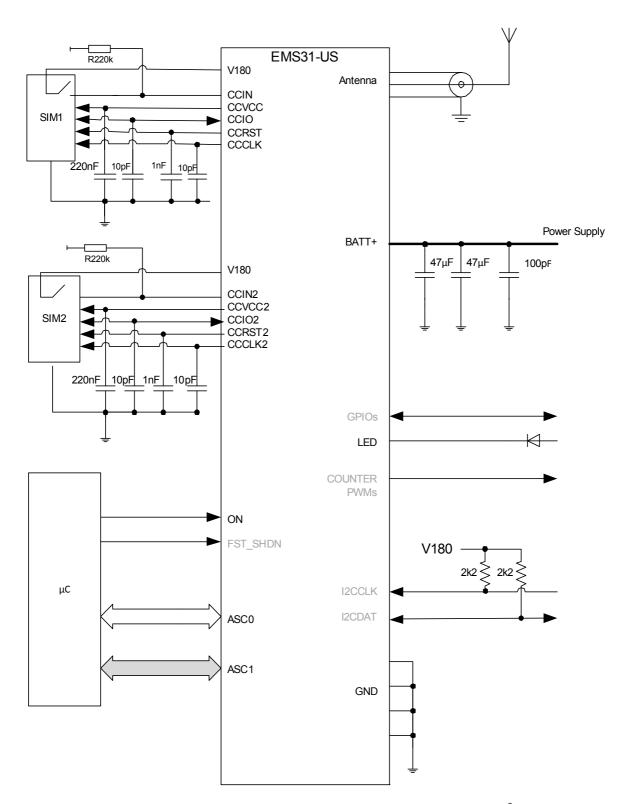
Because of the high RF field density inside the module, it cannot be guaranteed that no self interference might occur, depending on frequency and the applications grounding concept. The potential interferers may be minimized by placing small capacitors (47pF) at suspected lines (e.g. RXD0, or ON).

While developing SMT applications it is strongly recommended to provide test points for certain signals, i.e., lines to and from the module - for debug and/or test purposes. The SMT application should allow for an easy access to these signals. For details on how to implement test points see [3].

The EMC measures are best practice recommendations. In fact, an adequate EMC strategy for an individual application is very much determined by the overall layout and, especially, the position of components.

Note: EMS31-V is not intended for use with cables longer than 3m.

Disclaimer: No warranty, either stated or implied, is provided on the sample schematic diagram shown in Figure 5 and the information detailed in this section. As functionality and compliance with national regulations depend to a great amount on the used electronic components and the individual application layout manufacturers are required to ensure adequate design and operating safeguards for their products using EMS31-V module.



Note: The following features are not yet available with the current product release: GPIO, I²C, Pulse Counter, PWM, FST_SHDN, SPI, ADC and 2nd SIM/MIM. Second SIM/MIM interface is hardware prepared only.

Figure 5: Schematic diagram of EMS31-V sample application

3 Operating Characteristics

3.1 Operating Modes

The table below briefly summarizes the various operating modes referred to throughout the document.

Table 4: Overview of operating modes

Mode	Function		
Normal opera- tion	Active TX	LTE data transfer in progress. Power consumption depends on network settings, data transfer rate and radio conditions. No data transfer is in progress and no active communication via ASC0/ASC1.	
	IDLE	No data transfer is in progress. The LTE part of the device can be in LTE DRX, LTE eDRX or LTE PSM mode. Activity on ASC0 /ASC1 interfaces can be present. Power consumption depends on the LTE power saving mode and its parameters and on the activity on the ASC interfaces.	
Sleep	The module is in low power consumption state. There is no activity inside the module but module preserves the state in which it was before entering the sleep mode, including the electrical states of the GPIOs. The module will enter sleep state only when the LTE part of the module is in LTE DRX, LTE eDRX or LTE PSM mode or if it is in airplane mode. To allow sleep mode the host application shall indicate via RTS lines that it has no intention to send data.		
Power Down	Normal shutdown after sending the power down command. Software is not active. Interfaces are not accessible. Operating voltage remains applied.		
Airplane mode	Airplane mode shuts down the radio part of the module, causes the module to log off from the LTE network and disables all AT commands whose execution requires a radio connection. Airplane mode can be controlled by AT command (see [1]). Sleep mode can be entered when airplane mode is enabled.		

3.2 Power Supply

The power supply of EMS31-V has to be a single voltage source at BATT+. It must be able to provide the current for all operation modes of the module.

All the key functions for supplying power to the device are handled by the power management section of the analog controller. This IC provides the following features:

- Stabilizes the supply voltages for the baseband using low drop linear voltage regulators and a DC-DC step down switching regulator.
- Switches the module's power voltages for the power-up and -down procedures.
- SIM switch to provide SIM power supply.

4 Mechanical Dimensions, Mounting and Packaging

The following sections describe the mechanical dimensions of EMS31-V and give recommendations for integrating EMS31-V into the host application.

4.1 Mechanical Dimensions of EMS31-V

Figure 6 shows the top and bottom view of EMS31-V and provides an overview of the board's mechanical dimensions. For further details see Figure 7.

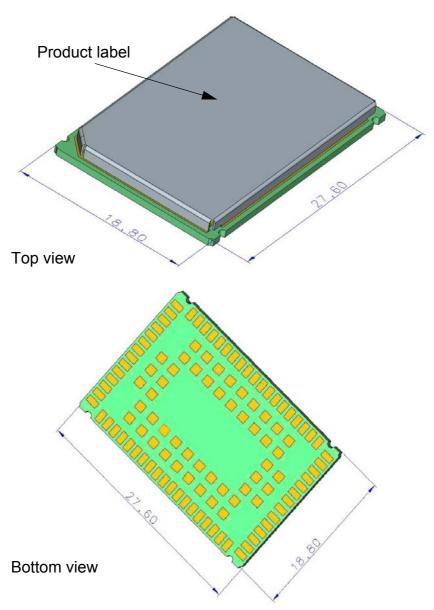


Figure 6: EMS31-V - top and bottom view

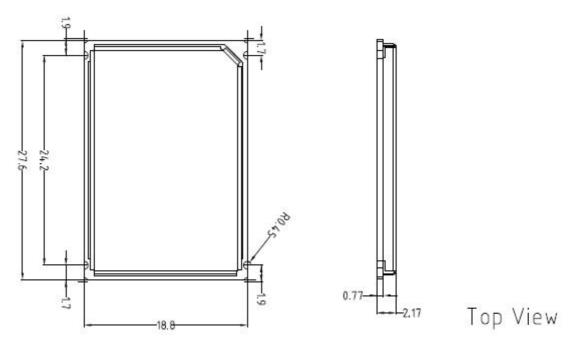


Figure 7: Dimensions of EMS31-V (all dimensions in mm)

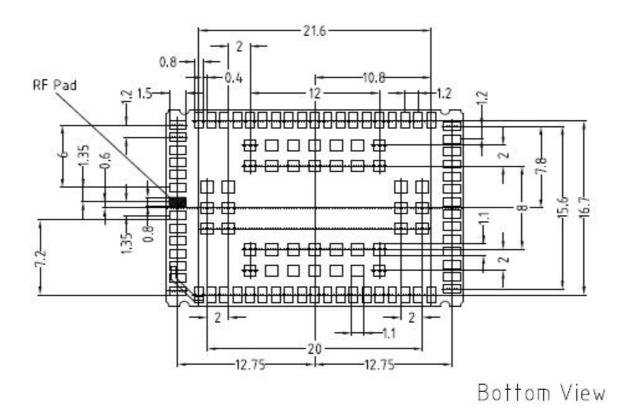


Figure 8: Dimensions of EMS31-V (all dimensions in mm) - bottom view

5 Regulatory and Type Approval Information

5.1 Directives and Standards

EMS31-V is designed to comply with the directives and standards listed below.

It is the responsibility of the application manufacturer to ensure compliance of the final product with all provisions of the applicable directives and standards as well as with the technical specifications provided in the "EMS31-V Hardware Interface Description".

Table 5: Directives

2002/95/EC (RoHS 1) 2011/65/EC (RoHS 2)	Directive of the European Parliament and of the Council of 27 January 2003 (and revised on 8 June 2011) on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS)	RoH5 compliant
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Table 6: Standards of North American type approval

CFR Title 47	Code of Federal Regulations, Part 22 and Part 24 (Telecommunications, PCS); US Equipment Authorization FCC
OET Bulletin 65 (Edition 97-01)	Evaluating Compliance with FCC Guidelines for Human Exposure to Radiofrequency Electromagnetic Fields
UL 60 950-1	Product Safety Certification (Safety requirements)
California Leadfree Man- date	Covered by European RoHS requirements
RSS130 (Issue 1) RSS133 (Issue 5) RSS139 (Issue 3)	Canadian Standard

 Table 7: Standards of Verizon type approval

Verizon Wireless Unified Module Process for Compliance Testing and Approval, October 2014		
Verizon Wireless Device Requirements LTE 3GPP Band 13 Network Access, October 2014		
3GPP2 C.S0015-A v1.0 Short Message Service for spread spectrum systems		

Table 8: Standards of GCF and PTCRB type approval

3GPP TS 51.010-1	Digital cellular telecommunications system (Release 13); Mobile Station (MS) conformance specification;
GCF-CC V3.58	Global Certification Forum - Certification Criteria
NAPRD03 V5.32	Version Specific Technical Overview of PTCRB Mobile/User Equipment Type Certification

Table 9: Requirements of quality

IEC 60068	Environmental testing
DIN EN 60529	IP codes

Table 10: Standards of the Ministry of Information Industry of the People's Republic of China

SJ/T 11363-2006	"Requirements for Concentration Limits for Certain Hazardous Substances in Electronic Information Products" (2006-06).
SJ/T 11364-2006	"Marking for Control of Pollution Caused by Electronic Information Products" (2006-06).
	According to the "Chinese Administration on the Control of Pollution caused by Electronic Information Products" (ACPEIP) the EPUP, i.e., Environmental Protection Use Period, of this product is 20 years as per the symbol shown here, unless otherwise marked. The EPUP is valid only as long as the product is operated within the operating limits described in the Gemalto M2M Hardware Interface Description.
	Please see Table 11 for an overview of toxic or hazardous substances or elements that might be contained in product parts in concentrations above the limits defined by SJ/T 11363-2006.

Table 11: Toxic or hazardous substances or elements with defined concentration limits

部件名称	有毒有害物质或元素 Hazardous substances					
Name of the part	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
金属部件 (Metal Parts)	0	0	0	0	0	0
电路模块 (Circuit Modules)	х	0	0	0	0	0
电缆及电缆组件 (Cables and Cable Assemblies)	0	0	0	0	0	0
塑料和聚合物部件 (Plastic and Polymeric parts)	0	0	0	0	0	0

0:

表示该有毒有害物质在该部件所有均质材料中的含量均在SJ/T11363-2006 标准规定的限量要求以下。 Indicates that this toxic or hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement in SJ/T11363-2006.

X:

表示该有毒有害物质至少在该部件的某一均质材料中的含量超出SJ/T11363-2006标准规定的限量要求。 Indicates that this toxic or hazardous substance contained in at least one of the homogeneous materials used for this part *might exceed* the limit requirement in SJ/T11363-2006.

5.2 SAR requirements specific to portable mobiles

Mobile phones, PDAs or other portable transmitters and receivers incorporating a GSM module must be in accordance with the guidelines for human exposure to radio frequency energy. This requires the Specific Absorption Rate (SAR) of portable EMS31-V based applications to be evaluated and approved for compliance with national and/or international regulations.

Since the SAR value varies significantly with the individual product design manufacturers are advised to submit their product for approval if designed for portable use. For US markets the relevant directives are mentioned below. It is the responsibility of the manufacturer of the final product to verify whether or not further standards, recommendations or directives are in force outside these areas.

Products intended for sale on US markets

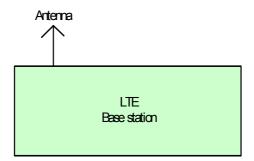
ES 59005/ANSI C95.1 Considerations for evaluation of human exposure to Electromagnetic Fields (EMFs) from Mobile Telecommunication Equipment (MTE) in the frequency range 30MHz - 6GHz

Please note that SAR requirements are specific only for portable devices and not for mobile devices as defined below:

- Portable device:
 - A portable device is defined as a transmitting device designed to be used so that the radiating structure(s) of the device is/are within 20 centimeters of the body of the user.
- Mobile device:
 - A mobile device is defined as a transmitting device designed to be used in other than fixed locations and to generally be used in such a way that a separation distance of at least 20 centimeters is normally maintained between the transmitter's radiating structure(s) and the body of the user or nearby persons. In this context, the term "fixed location" means that the device is physically secured at one location and is not able to be easily moved to another location.

5.3 Reference Equipment for Type Approval

The Gemalto M2M reference setup submitted to type approve EMS31-V (including a special approval adapter for the DSB75) is shown in the following figure¹:



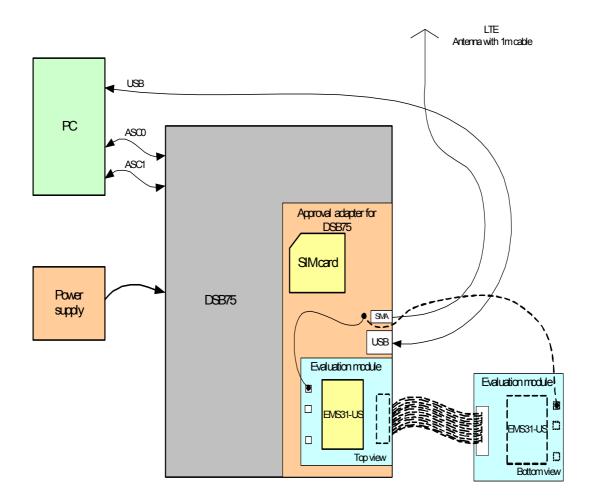


Figure 9: Reference equipment for Type Approval

Hirose SMA-Jack/U.FL-Plug conversion adapter HRMJ-U.FLP(40) (for details see see http://www.hirose-connectors.com/ or http://www.farnell.com/ Aeroflex Weinschel Fixed Coaxial Attenuator Model 3T/4T

(for details see http://www.aeroflex.com/ams/weinschel/pdfiles/wmod3&4T.pdf)

For RF performance tests a mini-SMT/U.FL to SMA adapter with attached 6dB coaxial attenuator is chosen to connect the evaluation module directly to the LTE test equipment instead of employing the SMA antenna connectors on the EMS31-V-DSB75 adapter as shown in Figure 9. The following products are recommended:

5.4 Compliance with FCC Rules and Regulations

The Equipment Authorization Certification for the Gemalto M2M reference application described in Section 5.3 will be registered under the following identifiers:

EMS31-V:

FCC Identifier: QIPEMS31-V

Manufacturers of mobile or fixed devices incorporating EMS31-V modules are authorized to use the FCC Grants of the EMS31-V modules for their own final products according to the conditions referenced in these documents. In this case, an FCC label of the module shall be visible from the outside, or the host device shall bear a second label stating "Contains FCC ID: QIPEMS31-V". The integration is limited to fixed or mobile categorized host devices, where a separation distance between the antenna and any person of min. 20cm can be assured during normal operating conditions.

For mobile and fixed operation configurations the antenna gain, including cable loss, must not exceed the limits in the following Table 12 for FCC.

Table 12: Antenna gain limits for FCC

Operating band	FCC limit	Unit
Maximum gain in lower operating bands with f< 1GHz (LTE Bd13)	8.91	dBi

IMPORTANT:

Manufacturers of portable applications incorporating EMS31-V modules are required to have their final product certified and apply for their own FCC Grant related to the specific portable mobile. This is mandatory to meet the SAR requirements for portable mobiles (see Section 5.2 for detail).

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Note: Manufacturers/OEM Integrators must ensure that the final user documentation does not contain any information on how to install or remove the module from the final product.

5.4 Compliance with FCC Rules and Regulations

Notes (FCC):

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

6 Document Information

6.1 Revision History

Preceding document: Cinterion® EMS31-V Hardware Interface Description Version 00.001 New document: Cinterion® EMS31-V Hardware Interface Description Version 00.002

Chapter	What is new
4.1	Replaced old Figure 7 and Figure 8 to up-to-date figures.
5.1	Revised standards listed in Table 6.
5.4	Revised FCC statements and removed ISED statements. Updated Table 12 for antenna gain limits.

New document: Cinterion® EMS31-V Hardware Interface Description Version 00.001

Chapter	What is new
	Initial document setup

6.2 Related Documents

- [1] EMS31-V AT Command Set
- [2] EMS31-V Release Note
- [3] Application Note 48: SMT Module Integration
- [4] Universal Serial Bus Specification Revision 2.0, April 27, 2000

6.3 Terms and Abbreviations

Abbreviation	Description
ADC	Analog-to-digital converter
AGC	Automatic Gain Control
ANSI	American National Standards Institute
ARFCN	Absolute Radio Frequency Channel Number
ARP	Antenna Reference Point
ASC0/ASC1	Asynchronous Controller. Abbreviations used for first and second serial interface of the module
В	Thermistor Constant
BER	Bit Error Rate
BTS	Base Transceiver Station
CB or CBM	Cell Broadcast Message
CE	Conformité Européene (European Conformity)
CHAP	Challenge Handshake Authentication Protocol
CPU	Central Processing Unit
CS	Coding Scheme
CSD	Circuit Switched Data
CTS	Clear to Send
DAC	Digital-to-Analog Converter
DAI	Digital Audio Interface
dBm0	Digital level, 3.14dBm0 corresponds to full scale, see ITU G.711, A-law
DCE	Data Communication Equipment (typically modems, e.g. Gemalto M2M module)
DCS 1800	Digital Cellular System, also referred to as PCN
DNI	Does not implemented
DRX	Discontinuous Reception
DSB	Development Support Box
DSP	Digital Signal Processor
DSR	Data Set Ready
DTE	Data Terminal Equipment (typically computer, terminal, printer or, for example, GSM application)

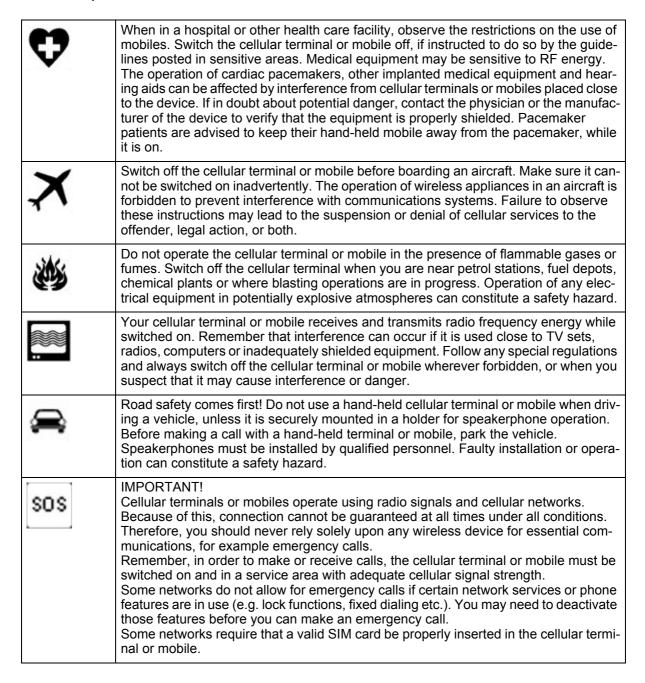
Abbreviation	Description
DTR	Data Terminal Ready
DTX	Discontinuous Transmission
eDRX	Enhanced Discontinuous Reception
EFR	Enhanced Full Rate
EGSM	Enhanced GSM
EIRP	Equivalent Isotropic Radiated Power
EMC	Electromagnetic Compatibility
ERP	Effective Radiated Power
ESD	Electrostatic Discharge
ETS	European Telecommunication Standard
FCC	Federal Communications Commission (U.S.)
FDMA	Frequency Division Multiple Access
FR	Full Rate
GMSK	Gaussian Minimum Shift Keying
GPIO	General Purpose Input/Output
GPRS	General Packet Radio Service
GSM	Global Standard for Mobile Communications
HiZ	High Impedance
HR	Half Rate
HSIC	High-Speed Inter-Chip
I/O	Input/Output
IC	Integrated Circuit
IMEI	International Mobile Equipment Identity
ISO	International Standards Organization
ITU	International Telecommunications Union
kbps	kbits per second
LED	Light Emitting Diode
Li-lon/Li+	Lithium-lon
Li battery	Rechargeable Lithium Ion or Lithium Polymer battery
LTE	Long Term Evolution
Mbps	Mbits per second
MIM	Machine Identification Module
MMI	Man Machine Interface
MO	Mobile Originated
MS	Mobile Station (GSM module), also referred to as TE
MSISDN	Mobile Station International ISDN number
MT	Mobile Terminated

Abbreviation	Description
NI	Not implemented
NTC	Negative Temperature Coefficient
OEM	Original Equipment Manufacturer
PA	Power Amplifier
PAP	Password Authentication Protocol
PBCCH	Packet Switched Broadcast Control Channel
PCB	Printed Circuit Board
PCL	Power Control Level
PCM	Pulse Code Modulation
PCN	Personal Communications Network, also referred to as DCS 1800
PCS	Personal Communication System, also referred to as GSM 1900
PLL	Phase Locked Loop
PPP	Point-to-point protocol
PTCRB	PCS Type Certification Review Board
PSK	Phase Shift Keying
PSU	Power Supply Unit
RAM	Random Access Memory
RED	Radio Equipment Directive
RF	Radio Frequency
RLS	Radio Link Stability
RoHS	Restriction of the use of certain hazardous substances in electrical and electronic equipment.
RTS	Request to Send
Rx	Receive Direction
SAR	Specific Absorption Rate
SAW	Surface Acoustic Wave
SDIO	Secure Digital Input Output
SELV	Safety Extra Low Voltage
SIM	Subscriber Identification Module
SMD	Surface Mount Device
SMS	Short Message Service
SMT	Surface Mount Technology
SRAM	Static Random Access Memory
TA	Terminal adapter (e.g. GSM module)
TDMA	Time Division Multiple Access
TE	Terminal Equipment, also referred to as DTE
TLS	Transport Layer Security
Tx	Transmit Direction
	•

Abbreviation	Description
UART	Universal asynchronous receiver-transmitter
UICC	Universal Integrated Circuit Card
URC	Unsolicited Result Code
USIM	Universal Subscriber Identity Module
USSD	Unstructured Supplementary Service Data
VSWR	Voltage Standing Wave Ratio

6.4 Safety Precaution Notes

The following safety precautions must be observed during all phases of the operation, usage, service or repair of any cellular terminal or mobile incorporating EMS31-V. Manufacturers of the cellular terminal are advised to convey the following safety information to users and operating personnel and to incorporate these guidelines into all manuals supplied with the product. Failure to comply with these precautions violates safety standards of design, manufacture and intended use of the product. Gemalto M2M assumes no liability for customer's failure to comply with these precautions.



7 Appendix

7.1 List of Parts and Accessories

Table 13: List of parts and accessories

Description	Supplier	Ordering information	
EMS31-V	Gemalto M2M	Standard module Gemalto M2M IMEI: Packaging unit (ordering) number: L30960-N4500-A200 Module label number: S30960-S4500-A200-1 ¹	
EMS31-V Evaluation Module	Gemalto M2M	Ordering number: L30960-N4501-A200	
DSB75 Evaluation Kit	Gemalto M2M	Ordering number: L36880-N8811-A100	
DSB Mini Compact Evaluation Board	Gemalto M2M	Ordering number: L30960-N0030-A100	
Starter Kit B80	Gemalto M2M	Ordering Number L30960-N0040-A100	
Multi-Adapter R1 for mount- ing EMS31-V evaluation modules onto DSB75	Gemalto M2M	Ordering number: L30960-N0010-A100	
Approval adapter for mounting EMS31-V evaluation modules onto DSB75	Gemalto M2M	Ordering number: L30960-N2301-A100	
SIM card holder incl. push button ejector and slide-in tray	Molex	Ordering numbers: 91228 91236 Sales contacts are listed in Table 14.	

^{1.} Note: At the discretion of Gemalto M2M, module label information can either be laser engraved on the module's shielding or be printed on a label adhered to the module's shielding.

Table 14: Molex sales contacts (subject to change)

Molex For further information please click: http://www.molex.com	Molex Deutschland GmbH Otto-Hahn-Str. 1b 69190 Walldorf Germany Phone: +49-6227-3091-0 Fax: +49-6227-3091-8100 Email: mxgermany@molex.com	American Headquarters Lisle, Illinois 60532 U.S.A. Phone: +1-800-78MOLEX Fax: +1-630-969-1352
Molex China Distributors Beijing, Room 1311, Tower B, COFCO Plaza No. 8, Jian Guo Men Nei Street, 100005 Beijing P.R. China Phone: +86-10-6526-9628 Fax: +86-10-6526-9730	Molex Singapore Pte. Ltd. 110, International Road Jurong Town, Singapore 629174 Phone: +65-6-268-6868 Fax: +65-6-265-6044	Molex Japan Co. Ltd. 1-5-4 Fukami-Higashi, Yamato-City, Kanagawa, 242-8585 Japan Phone: +81-46-265-2325 Fax: +81-46-265-2365

About Gemalto

Since 1996, Gemalto has been pioneering groundbreaking M2M and IoT products that keep our customers on the leading edge of innovation.

We work closely with global mobile network operators to ensure that Cinterion[®] modules evolve in sync with wireless networks, providing a seamless migration path to protect your IoT technology investment

Cinterion products integrate seamlessly with Gemalto identity modules, security solutions and licensing and monetization solutions, to streamline development timelines and provide cost efficiencies that improve the bottom line.

As an experienced software provider, we help customers manage connectivity, security and quality of service for the long lifecycle of IoT solutions.

For more information please visit

www.gemalto.com/m2m, www.facebook.com/gemalto, or Follow@gemaltoloT on Twitter.

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